

## FEATURES

- | Size Design  $\Phi 8.0*6.0\text{mm}$
- | High Current Handling Capability  $10,000\text{A}$  @  $8/20\ \mu\text{s}$
- | Low Capacitance and Insertion Loss
- | Quick Response and Long Service Life
- | Moisture sensitivity level: Level 1
- | High Reliability and Automobile Grade(AEC-Q200)



Schematic Symbol

## APPLICATION INFORMATION

- | Communication equipment.
- | Repeaters, Modems
- | Telephone Interface, Line cards.
- | Data communication equipment.

## AGENCY APPROVALS

Icon	Solderability
RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003
	Mean lead free

## PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated

## ELECTRICAL PARAMETER

Parameter	Symbol	Limit	Unit
DC Blocking Voltage 1)	100V/s	640-960	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values $\leq 1600$	V
	At 1kV/μs	Typical values of distribution $\leq 1500$	V
Impulse Discharge Current 2)	8/20μs $\pm 5$ times	10	KA
Insulation Resistance	DC=100V	$\geq 1$	GΩ
Capacitance at 1MHz	$V_{DC}=0.5V$	$\leq 1.5$	pF
Operating and Storage Temperature		-40~125	°C

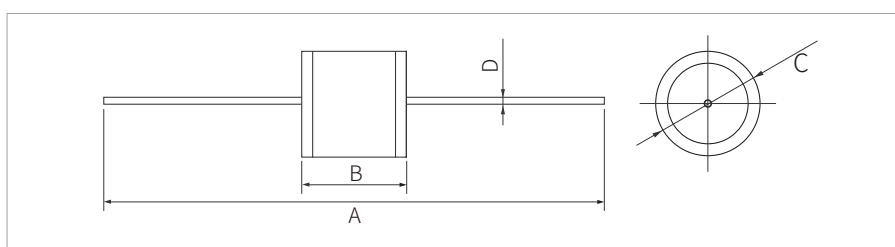
1) In ionized mode

2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

## ENVIRONMENTAL RELIABILITY CHARACTERISTICS

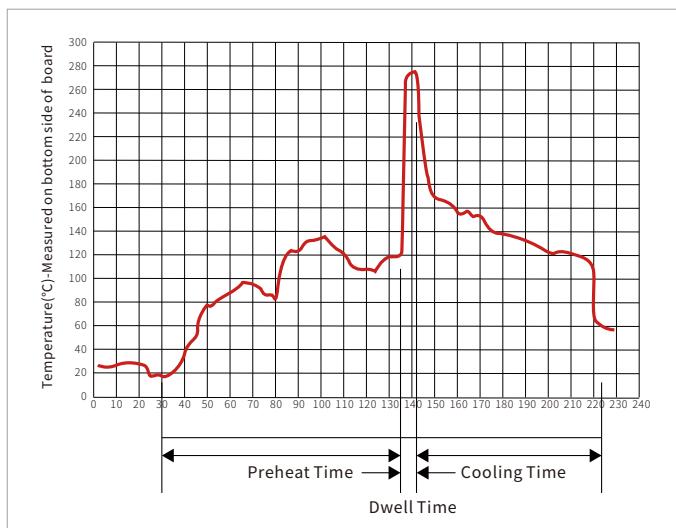
Testing items	Technical standards
High Temperature Storage Test	Temperature: 125°C ; Time:2H
Low Temperature Storage Test	Temperature: -40°C ; Time:2H
Vibration	Frequency: 10-500Hz ; Amplitude:0.15mm ; Time:45min
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering:10s,1time

## PRODUCT DIMENSIONS



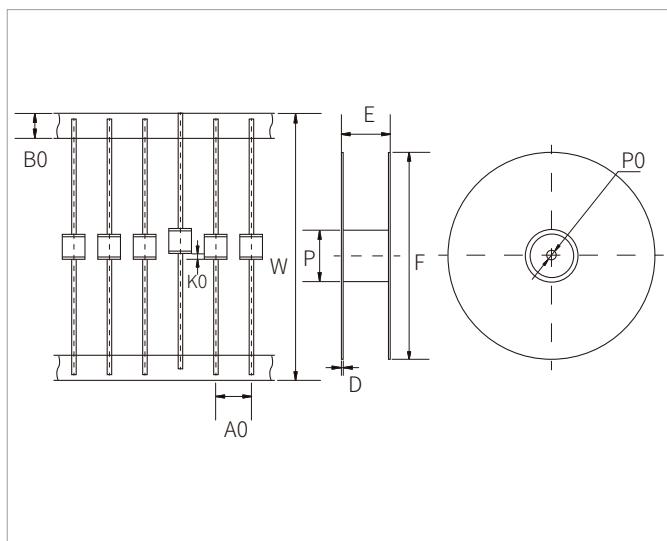
Ref.	Outline Dimensions
	Millimeters
A	62±2
B	6±0.2
C	Φ8.0±0.2
D	Φ0.8

## WAVE SOLDERING



Wave Parameter	Lead-free assembly
Pre Heat	Temperature Min 100°C
	Temperature Max 150°C
	Time(min to max) 60 – 180 secs
Solder pot Temperature	280°C Max
Solder Dwell Time	2-5 seconds

## TAPE AND REEL SPECIFICATION



Ref.	Dimensions	
	Millimeters	Inches
W	65±2	2.559±0.079
A0	10±0.5	0.394±0.020
B0	6±1	0.236±0.012
K0	1.2 Max.	0.47 Max.
D	2.5±0.5	0.098±0.020
F	340±2	13.39±0.079
E	73±2	2.874±0.079
P	82±2	3.228±0.079
P0	Φ16±1	Φ0.63±0.039

## ORDERING INFORMATION

Part Number	Size	Marking	Qty/pcs	
			Reel	Carton
TPSG2R08B800	Φ8.0*6.0mm	SG800_08	1000	4000

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**By QR Code**

Website



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